

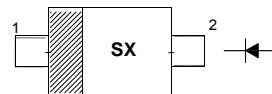
SMALL SIGNAL SCHOTTKY DIODE

Features

- Low forward voltage drop

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Top View
Marking Code: "SX"
Simplified outline SOD-323 and symbol

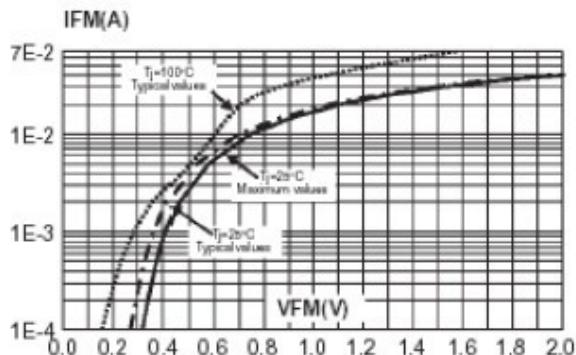
Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	70	V
Continuous Forward Current	I_F	70	mA
Surge Non-Repetitive Forward Current ($t_p = 10 \text{ ms}$)	I_{FSM}	1	A
Total Power Dissipation	P_{tot}	230	mW
Thermal Resistance Junction to Ambient ¹⁾	R_{thJA}	550	$^\circ\text{C}/\text{W}$
Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	- 65 to + 150	$^\circ\text{C}$

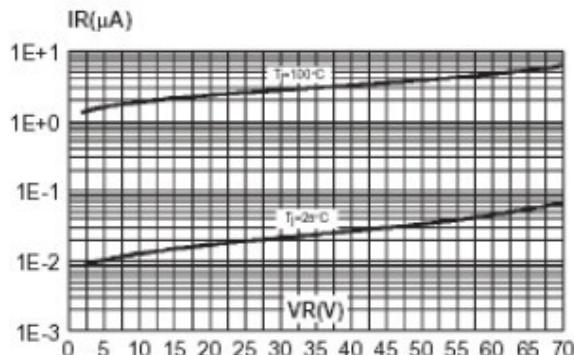
¹⁾ Mounted on epoxy board, with recommended pad layout.

Characteristics at $T_a = 25^\circ\text{C}$

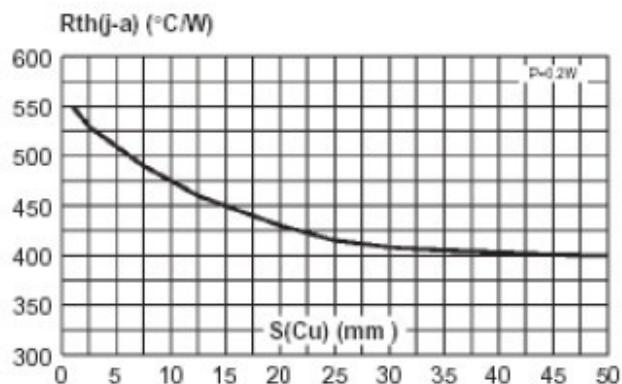
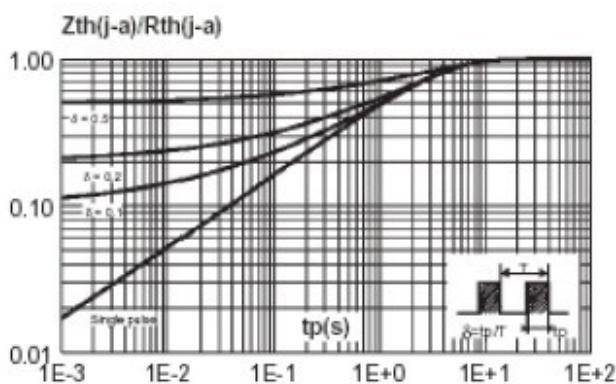
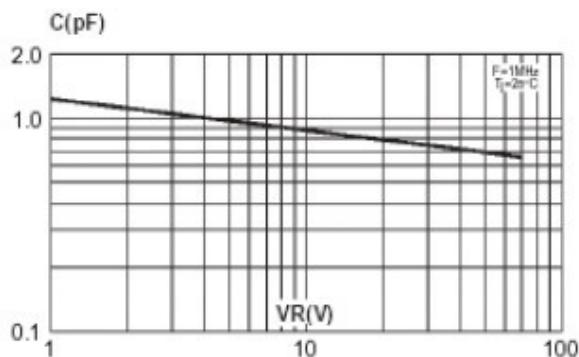
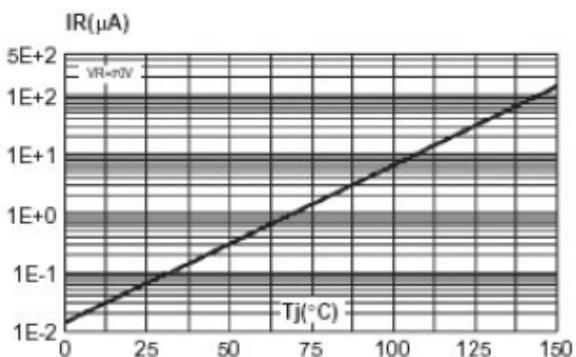
Parameter	Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at $I_R = 10 \mu\text{A}$	V_{BR}	70	-	V
Forward Voltage at $I_F = 1 \text{ mA}$	V_F	-	410	mV
Reverse Current at $V_R = 50 \text{ V}$	I_R	-	100	nA
Diode Capacitance at $V_R = 0 \text{ V}, f = 1 \text{ MHz}$	C_{tot}	-	2	pF



Reverse leakage current versus junction temperature (typical values).



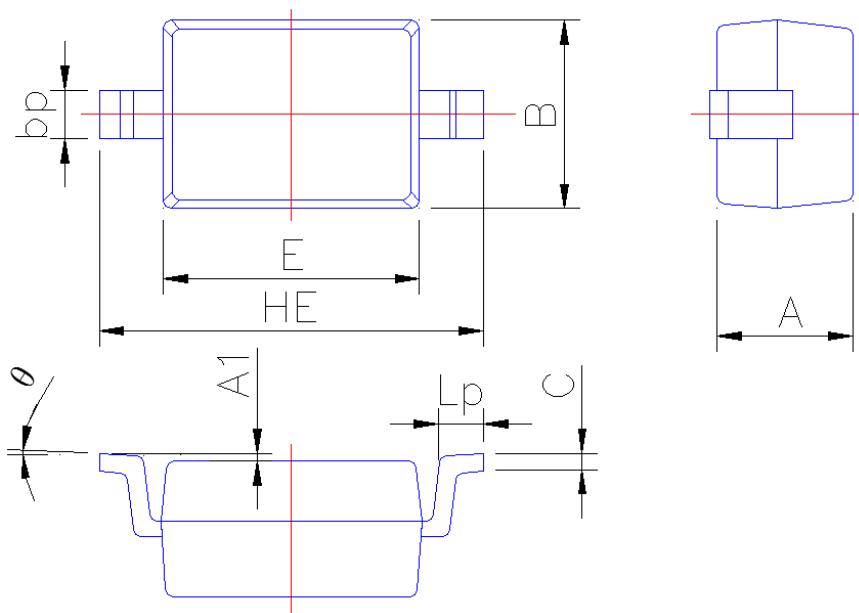
Junction capacitance versus reverse voltage applied (typical values).



PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-323



Symbol	Dimension in Millimeters	
	Min	Max
A	0.95	1.15
A1	0.010	0.100
B	1.20	1.40
bp	0.25	0.40
C	0.09	0.150
E	1.60	1.80
HE	2.30	2.70
Lp	0.20	0.40
θ	0°	5°